

# Thermal tunable one-dimensional photonic crystals containing phase change material\*

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To obtain the adjustable photonic crystals (PCs), we numerically investigate one-dimensional (1D) PCs with alternating VO<sub>2</sub> and SiO<sub>2</sub> layers through transfer matrix method. The dispersion relation agrees well with the transmittance obtained by the finite element calculation. Tunable band gaps are achieved with the thermal stimuli of VO<sub>2</sub>, which has two crystal structures. The monoclinic crystal structure VO<sub>2</sub> (R) at low temperature exhibits insulating property, and the high temperature square rutile structure VO<sub>2</sub> (M) presents metal state. Concretely, the bandwidth is getting narrower and red shift occurs with the higher temperature in VO<sub>2</sub> (R)/SiO<sub>2</sub> PCs structure. Based on the phase change characteristics of VO<sub>2</sub>, we can flexibly adjust the original structure as VO<sub>2</sub> (R)/VO<sub>2</sub> (M)/SiO<sub>2</sub>. By increasing the phase ratio of VO<sub>2</sub> (R) to VO<sub>2</sub> (M), the band gap width gradually becomes wider and blue shift occurs. The discrete layers of gradient composites on the dispersion of 1D PCs are also investigated, which enhances the feasibility in practical operation. Thus, our proposed thermal modulation PCs structure paves a new way to realize thermal tunable optical filters and sensors.

**Keywords:** photonic crystals, VO<sub>2</sub>, thermal modulation, phase change

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## 1. Introduction

Photonic crystals (PCs) are artificial microstructures with periodic refractive index.<sup>[1]</sup> The incident electromagnetic wave scatters at the interface and the superposition of multiple scattering waves forms a photonic band gap, which is analogue to the electronic band gap in semiconductor.<sup>[2]</sup> Since the first discovery of PCs in 1987,<sup>[3,4]</sup> it can be divided into 1D,<sup>[5]</sup> 2D,<sup>[6]</sup> and 3D,<sup>[7]</sup> which has wide applications in optical fiber,<sup>[8]</sup> filter,<sup>[9]</sup> absorber,<sup>[10]</sup> and sensor.<sup>[11]</sup> The first artificial PC was fabricated in 1991, Yablonoitch drilled periodically holes in a dielectric material with a refractive index of 3.6 to achieve arbitrary angle filtering.<sup>[12]</sup> Compared with traditional PCs equipment, tunable PCs have the merits of flexible design, easy integration, and dynamic tuning. It can be achieved with the external modulation through electric,<sup>[13]</sup> magnetic,<sup>[14]</sup> optical,<sup>[15]</sup> mechanic,<sup>[16]</sup> and thermal<sup>[17]</sup> stimuli.

The emergence of liquid crystal,<sup>[18]</sup> graphene,<sup>[19]</sup> and phase change material<sup>[20]</sup> provides another way to obtain a tunable photonic band gap. In 2013, Fan *et al.* designed 1D gradient soft PCs composing of alternating ferromagnetic layers and dielectric layers to achieve magnetically regulated PCs.<sup>[21]</sup> In 2016, Liu *et al.* realized an electrically controlled optical fiber polarization filter based on liquid crystal materials.<sup>[22]</sup> In 2019, Fatemeh *et al.* used PCs with alternating layers of graphene and silica plates to achieve a tunable filter by adjusting the conductivity of graphene.<sup>[23]</sup> The phase change material VO<sub>2</sub> will convert from insulating phase

to metal phase under thermal triggering. In 2012, Fan *et al.* designed a waveguide PC coated with VO<sub>2</sub> layer to implement a terahertz modulator.<sup>[24]</sup> 2D PCs containing spherical SiO<sub>2</sub>/VO<sub>2</sub> core/shell nanoparticles were proposed for thermochromic smart window applications.<sup>[20]</sup> In 2017, Liang *et al.* sputtered VO<sub>2</sub> onto the silicon dioxide nanosphere arrays to get PCs, which have excellent near infrared modulation.<sup>[25]</sup> In 2019, Wang *et al.* developed a composite ink composed of VO<sub>2</sub> nanoparticles and polydimethylsiloxane to prepare 3D THz PCs by direct writing technology.<sup>[26]</sup> Even the PCs have such achievements, the challenge of active modulation still exists. Most work focused on the discrete thermal stimulation of VO<sub>2</sub> before or after the phase conversion. Here we theoretically investigate the influence of phase ratio between VO<sub>2</sub> (R) and VO<sub>2</sub> (M) on the dispersion relationship. Namely, the varied phase change layer with continuous thermal stimuli is fully examined.

In this paper, we have proposed 1D PCs structure with alternating VO<sub>2</sub> and SiO<sub>2</sub> layers to achieve a tunable band gap under thermal stimuli. The photonic band gap is numerical calculated with the transfer matrix method and agrees well with the finite element method (FEM). The band gap position and bandwidth of the 1D PCs are fully explored with the phase change of VO<sub>2</sub> from insulation phase to metal phase. Two sets of the proposed PCs structures are calculated for comparison with different portions of the phase states.

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## 2. Theoretical methods

**Transfer matrix method** The essence of the transfer matrix method is layer by layer calculation. It is extraordinary suitable for solving the PCs system to get the dispersion relation. Now we are in the position to consider the PCs with a lattice constant  $d$ . The electromagnetic wave can be expressed as  $[E_i(r) H_i(r)]^T$  at the incident surface.  $[E_i(r+d) H_i(r+d)]^T$  can be used to represent the form of

$$M_0^{\text{TE}}(d) = \begin{bmatrix} \cos(k_1 a) & \frac{1}{k_1} \sin(k_1 a) \\ -k_1 \sin(k_1 a) & \cos(k_1 a) \end{bmatrix} \begin{bmatrix} \cos(k_2 b) & \frac{1}{k_2} \sin(k_2 b) \\ -k_2 \sin(k_2 b) & \cos(k_2 b) \end{bmatrix} = \begin{bmatrix} A & B \\ C & D \end{bmatrix}. \quad (1)$$

According to the Bloch theorem in the periodic system, the dispersion relationship in 1D PCs can be indicated as follows:

$$\begin{aligned} \cos(kd) &= \frac{1}{2}(A+D) \\ &= \cos(k_1 a) \cos(k_2 b) - \gamma \sin(k_1 a) \sin(k_2 b), \quad (2) \\ \gamma &= \frac{1}{2} \left( \frac{k_2}{k_1} + \frac{k_1}{k_2} \right) \\ &= \frac{1}{2} \left( \frac{n_1 \cos(\theta_1)}{n_2 \cos(\theta_2)} + \frac{n_2 \cos(\theta_2)}{n_1 \cos(\theta_1)} \right), \quad (3) \end{aligned}$$

where  $k_i = n_i \omega \cos \theta_i / c$  ( $i = 1, 2$ ) represents the wave vector in the medium;  $\theta_i$  is the incident angle of light wave in the medium;  $a$  and  $b$  represent the thicknesses of VO<sub>2</sub> and SiO<sub>2</sub>, respectively. The speed of light in vacuum is  $c$ . The dispersion relationships of the TE wave and TM wave at normal incidence ( $\theta = 0^\circ$ ) are the same.

**Finite element method** FEM is a numerical method to solve the physical field with finite boundary. The basic principle is to divide the physical field into finite elements and nodes through discretization. Then, the variables in the differential equation describing the relevant physical quantities are transformed into the interpolation function form of each element. Finally, the Maxwell's equations are discretized and solved based on the variational principle. FEM is suitable for PCs with complex structure due to its high accuracy and versatility.<sup>[29]</sup>

VO<sub>2</sub> has two crystal structures.<sup>[30]</sup> The monoclinic crystal structure VO<sub>2</sub> (R) at low temperature exhibits insulating property, and the high temperature square rutile structure VO<sub>2</sub> (M) presents metal state. VO<sub>2</sub> will convert from monoclinic crystal structure to tetragonal rutile crystal structure triggered by temperature above 68 °C.<sup>[31]</sup> In the process of phase transition, the effective dielectric constant can be characterized with the effective medium theory<sup>[32]</sup> as follows:

$$\begin{aligned} \epsilon_{\text{eff}} &= \frac{1}{4} \{ \epsilon_i (2 - 3f) + \epsilon_m (3f - 1) \\ &+ \sqrt{[\epsilon_i (2 - 3f) + \epsilon_m (3f - 1)]^2 + 8\epsilon_i \epsilon_m} \}, \quad (4) \end{aligned}$$

the electromagnetic wave at the exit surface. Assuming that the matrix  $M$  satisfies the relation  $[E_i(r+d) H_i(r+d)]^T = M [E_i(r) H_i(r)]^T$ . The transmission process of electromagnetic waves in the PCs structure can be described through the transfer matrix  $M$ .<sup>[27]</sup> For the 1D PCs,  $2 \times 2$  transmission matrix depicts the propagation state of electromagnetic waves in each layer of the medium. The transfer matrix with TE wave can be expressed as<sup>[28]</sup>

where  $\epsilon_i$  is the dielectric constant of VO<sub>2</sub> (R) and equals to 9. The dielectric constant of VO<sub>2</sub> (M) can be expressed through the Drude model as  $\epsilon_m = \epsilon_i + i\omega_p^2 / \omega (\omega + i\tau^{-1})$ , where  $\omega_p$  is the plasma frequency and is taken as  $\omega_p = \sqrt{Ne^2 / \epsilon_0 m^*}$ . The effective mass  $m^* = 2m_e$ ,  $m_e$  denotes the mass of the free electron, the carrier density  $N = 8.7 \times 10^{21} \text{ cm}^{-3}$ , and  $\tau = 2.27 \text{ fs}$ .<sup>[33,34]</sup>  $f$  is the volume fraction of VO<sub>2</sub> (M) in the entire lattice. It is a temperature dependent quantity and can be expressed as  $f = 1 - 1 / (1 + \exp[(T - T_C) / \Delta T])$ . The phase transition temperature is  $T_C = 341 \text{ K}$ , and  $\Delta T = 6 \text{ }^\circ\text{C}$  is the hysteresis temperature. The relationship between the real part of the effective dielectric constant of VO<sub>2</sub> and temperature in THz region is illustrated in Fig. 1. It is clearly observed that the dielectric constant gets enhanced with the increase of temperature above 341 K. It is kept as a constant in the VO<sub>2</sub> (R) state below 341 K and represents a dielectric layer.

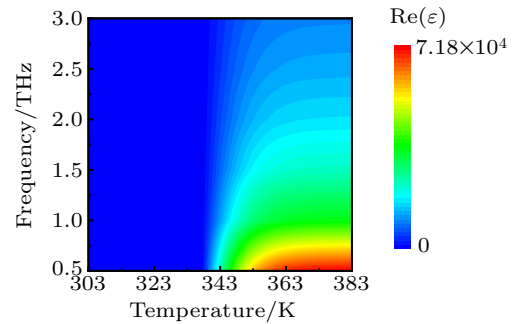


Fig. 1. Real part of the effective dielectric constant of VO<sub>2</sub> at different temperature in THz region.

## 3. Results and discussion

Figure 2 shows the 3D configuration and the cross section view of the proposed PCs structure, which is composed of alternating VO<sub>2</sub> (R) and SiO<sub>2</sub>. The incident light is in TE mode along the  $z$ -axis.  $N$  denotes the period and is taken as 10. The lattice constant  $d$  is 2  $\mu\text{m}$ . The thickness ratio of VO<sub>2</sub> (R) to SiO<sub>2</sub> is  $a : b = 3 : 2$ . The refractive index of SiO<sub>2</sub> is taken as 1.5 and the dielectric constant of VO<sub>2</sub> is given by Eq. (1).

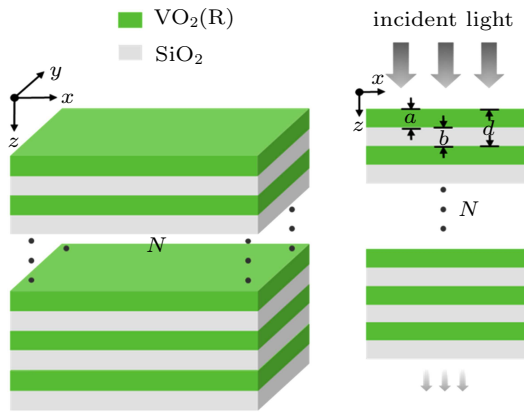


Fig. 2. The 3D configuration and the cross section view of the VO<sub>2</sub> (R)/SiO<sub>2</sub> PCs structure.

The dispersion relationship and transmittance of VO<sub>2</sub> (R)/SiO<sub>2</sub> PCs are illustrated in Fig. 3. It is obviously found that three photonic band gaps exist in the range of 0–125 THz in Fig. 3(a). The first band gap locates at 26.1–37.1 THz. The second band gap is in the region between 56.5 THz and 73.1 THz. The third band gap is from 91.5 THz to 106.6 THz. As a result, the electromagnetic wave is not allowed to propagate through the VO<sub>2</sub> (R)/SiO<sub>2</sub> PCs in this circumstance. The corresponding transmittance of the structure is numerically shown in Fig. 3(b). It is clearly found that the transmissivity is almost zero in the photonic band gap and achieves a good self-consistent with the band gap characteristics of the PCs, verifying the correctness of our results. Besides, the transmission spectrum range is not limited to 0–125 THz. It can be extended to high frequency region with careful chosen thickness ratio. The working frequency region can be extended to 125–200 THz while the relevant parameters are taken as  $d = 2 \mu\text{m}$  and the thickness ratio of VO<sub>2</sub> (R) to SiO<sub>2</sub> is  $a : b = 3 : 7$ . Thus, with a smaller thickness ratio between VO<sub>2</sub> (R) and SiO<sub>2</sub>, the transmission spectrum will have a significant blue shift.

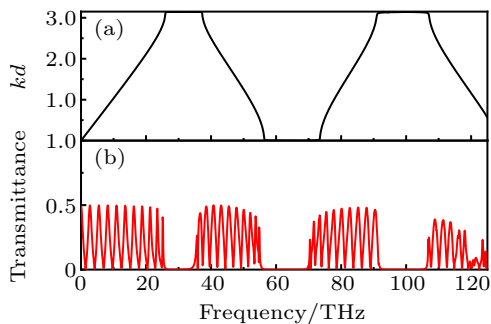


Fig. 3. (a) The dispersion relation of VO<sub>2</sub> (R)/SiO<sub>2</sub> PCs structure obtained with transfer matrix method. (b) The transmission spectrum of the structure obtained with numerical simulation.

The optical properties of VO<sub>2</sub> are closely related to the external temperature. Based on the phase transition characteristics of VO<sub>2</sub>, the influences of temperature on the dispersion relationship are explored in Fig. 4. A transition from the insu-

lating phase to the metal phase occurs at the critical temperature 341 K. In this process, there is a red shift in the dispersion relationship, and the band gap bandwidth is gradually decreasing. The first and second band gaps disappear when VO<sub>2</sub> is converted to metal phase at 350 K. With the phase change of VO<sub>2</sub> from insulating to metal phase, it is difficult for the low frequency electromagnetic waves to pass through the metallic interface due to multiple scattering overlapping. Thus, the photon band gap at low frequency will gradually disappear.

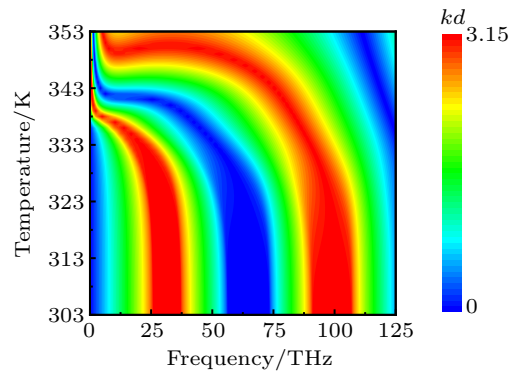


Fig. 4. The influence of temperature on the dispersion relation of VO<sub>2</sub> (R)/SiO<sub>2</sub> PCs in the range of 0–125 THz.

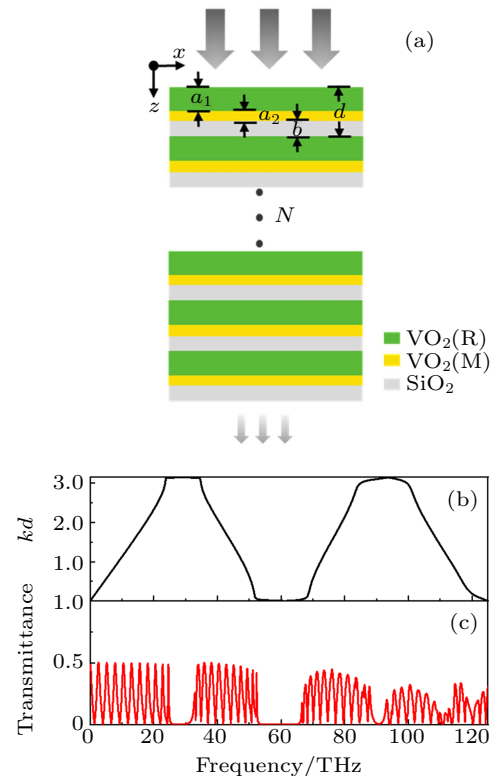


Fig. 5. (a) The 3D configuration and cross section view of the VO<sub>2</sub> (R)/VO<sub>2</sub> (M)/SiO<sub>2</sub> PCs structure. (b) The dispersion curve obtained with transfer matrix method. (c) The transmission spectrum of VO<sub>2</sub> (R)/VO<sub>2</sub> (M)/SiO<sub>2</sub> PCs structure obtained with numerical calculation.

To enrich the tunable properties of PCs, we make further adjustments to the VO<sub>2</sub> (R)/SiO<sub>2</sub> PCs structure. Now the VO<sub>2</sub> is divided into two parts (VO<sub>2</sub> (R)/VO<sub>2</sub> (M)). Figure 5(a) depicts 3D configuration and cross section view of the structure,

which is composed of three alternating layers VO<sub>2</sub> (R)/VO<sub>2</sub> (M)/SiO<sub>2</sub>.  $a_1$  and  $a_2$  are the thicknesses of VO<sub>2</sub> (R) and VO<sub>2</sub> (M). The parameters are chosen as follows:  $d = 2 \mu\text{m}$ ,  $a : b = 3 : 2$ , and  $N = 10$ . Figure 5(b) illustrates the dispersion relation and transmission spectrum with the thickness ratio  $a_1 : a_2 = 5 : 1$ . Compared to Fig. 3, the dispersion curve demonstrates a red shift, and the bandwidth of each band gap is getting smaller. Now the band gaps are in the ranges of 23.8–34.2 THz, 51.7–67.9 THz, and 89.5–95.8 THz respectively. In addition, the band gap will disappear in the higher frequency region. The band gap distribution in Fig. 5(b) is consistent with the transmittance in Fig. 5(c). It is revealed that the red shift of the dispersion relation and the decrease of the band gap are caused by the emergence of metal phase VO<sub>2</sub> (M). For the combined layer of VO<sub>2</sub> (R) and VO<sub>2</sub> (M), it can be regarded as a composite material layer. Its effective dielectric constant is obtained through series capacitance method.<sup>[35]</sup> When a new material is added to the composite layer, the effective dielectric constant of the composite layer will be reduced, resulting in the red shift of the dispersion relation and the reduction of the band gap width.

To verify the influence of VO<sub>2</sub> (M) on the dispersion relationship, the trend of the dispersion relationship through different thickness ratio of VO<sub>2</sub> (R) to VO<sub>2</sub> (M) is calculated in

Fig. 6. The thickness ratio of  $a_1 : a_2$  is from 0 to 1.0 with a thicker layer of VO<sub>2</sub> (R) in Fig. 6(c) and it is getting larger than 1.0 with a thicker layer of VO<sub>2</sub> (M) in Fig. 6(a). It can be intuitively found that the dispersion behavior of VO<sub>2</sub> (R) and VO<sub>2</sub> (M) is changing with different ratios. As the thickness of the VO<sub>2</sub> (M) continues to decrease, the dispersion relationship demonstrates a blue shift and the width of each band gap gradually increases. According to the series capacitance method, the effective dielectric constant of the composite layer increases with the decrease of the thickness of the metal phase. Consequently, the dielectric constant of the composite layer is significantly different from SiO<sub>2</sub>, leading to significant band shift of PCs. Besides, the position and band gap width of the first band gap are extracted in Figs. 6(b) and 6(d). In Fig. 6(b), when the proportion of VO<sub>2</sub> (M) is very low, the growth trend of both is relatively flat. When the thickness of the VO<sub>2</sub> (M) is larger than that of the VO<sub>2</sub> (R), the blue shift and growth trend are obvious in Fig. 6(d). After further calculation, we extract the position distributions of the second and the third band gaps with different ratios in Fig. 7. The results denote that the variations of the second and the third band gaps are the same as that of the first band gap. Namely, as the thickness of the metal phase decreases, the dispersion relationship blue shifts and the band gaps are getting smaller.

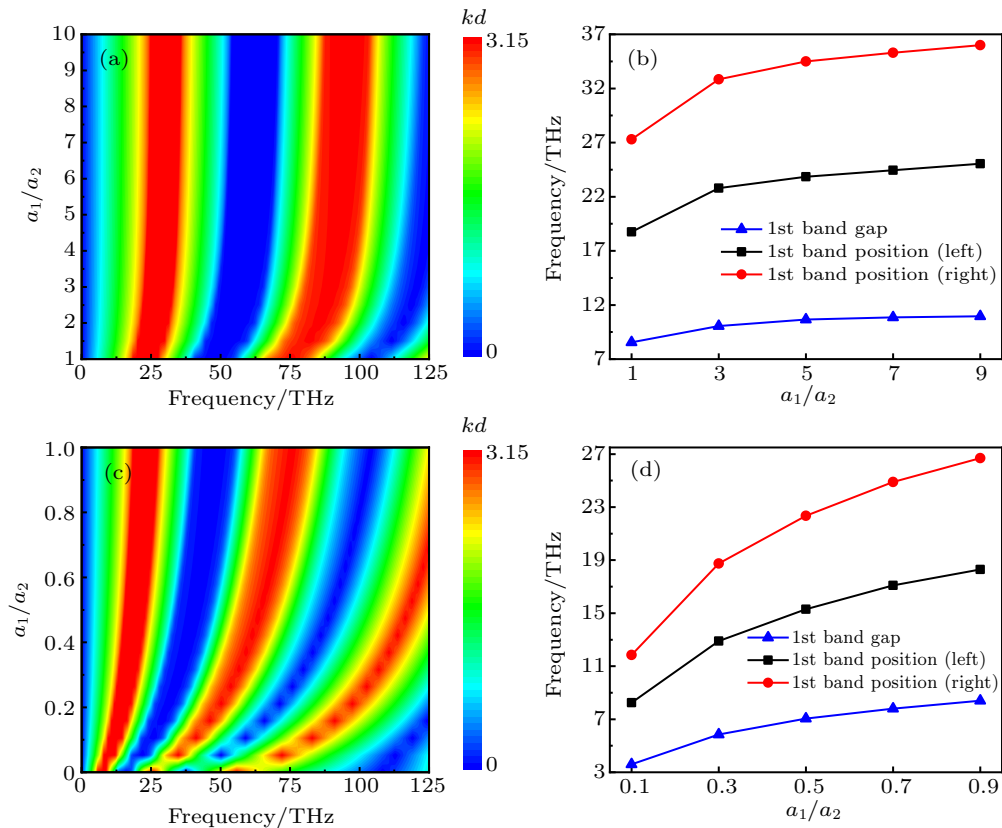


Fig. 6. (a) and (c) The influence of different proportions of VO<sub>2</sub> (R) and VO<sub>2</sub> (M),  $a_1/a_2$ , on the dispersion relation. (b) and (d) The position and band gap of the first band with different  $a_1/a_2$ .

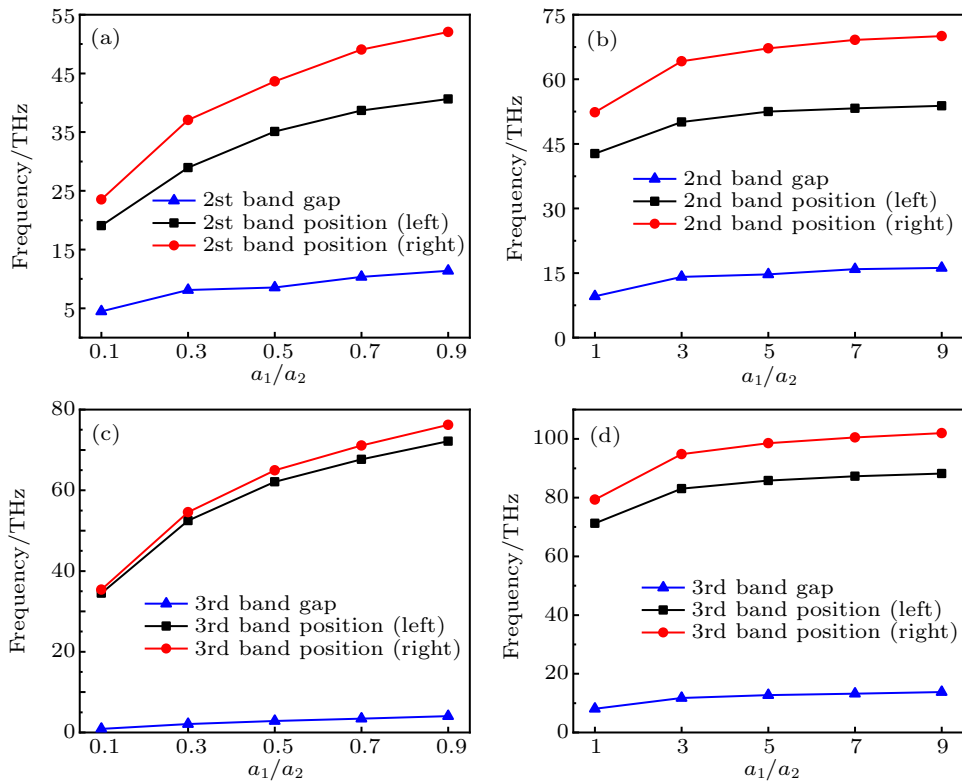


Fig. 7. (a) and (b) The position and band gap of the second band with different  $a_1/a_2$ . (c) and (d) The position and band gap of the third band with different  $a_1/a_2$ .

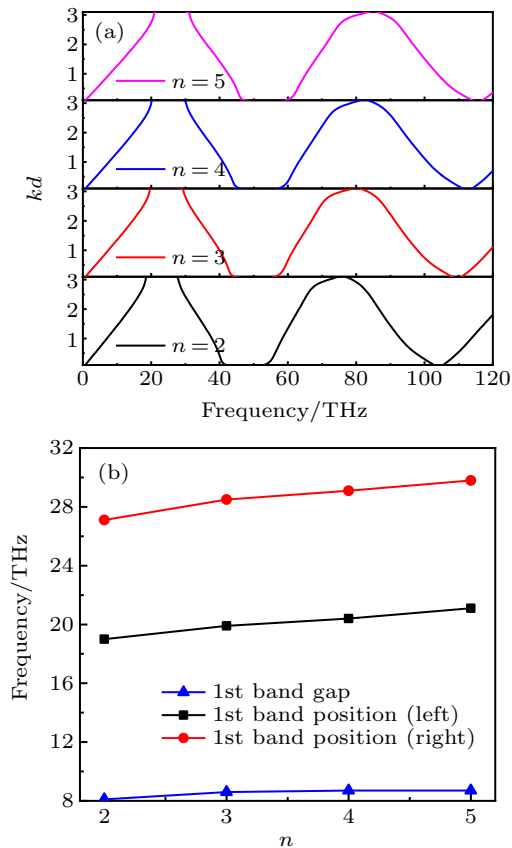


Fig. 8. (a) The dispersion curve of 1D PCs with different number of layers. (b) The position and the first band width with different layers of  $\text{VO}_2$ .

Finally, the number of layers on the dispersion of 1D PCs is considered in Fig. 8.  $\text{VO}_2$  is divided into  $n$  layers ( $n > 1$ ), the

first and the last layers are set at 303 K ( $\text{VO}_2$  (R)) and 343 K ( $\text{VO}_2$  (M)). As  $n$  increases, the temperature of each layer is evenly divided. The division is listed as follows: 2 layers,  $T = 303$  K, 343 K; 3 layers,  $T = 303$  K, 323 K, 343 K; 4 layers,  $T = 303$  K, 318 K, 333 K, 343 K; 5 layers:  $T = 303$  K, 313 K, 323 K, 333 K, 343 K. Figure 8(a) presents the dispersion relationship when  $\text{VO}_2$  is divided into different layers. When the temperature division becomes more intensive, the dispersion relationship undergoes a slight blue shift and the band gap width does not change significantly. Figure 8(b) shows the position and bandwidth of the first band gap. The band gap position is moving into higher frequency region with a larger  $n$ . The band gap width is slightly changed. Thus, to initiate the gradient temperature distribution, we can divide it into several separated parts with concrete thermal stimuli, which enhances the feasibility in practical operation.

#### 4. Conclusion

In summary, theoretical calculation of 1D PCs consisting of alternating vanadium oxide and dielectric layer with the transfer matrix method is conducted in this work. Our results of the dispersion relation coincide well with the numerical calculation of transmittance. The position and width of the band gap can be dynamically tuned with the different phase ratios of  $\text{VO}_2$  (R) to  $\text{VO}_2$  (M). Thermal tunable photonic band gap can be achieved with different portions of the metallic phase of  $\text{VO}_2$ . In addition, to initiate the gradient temperature distribu-

tion, we can divide it into several separated parts with concrete thermal stimuli, which enhances the feasibility in practical operation. Therefore, this work will guide some potential applications in the thermal tunable optical filters and sensors.

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